Silicon PIN Diode Switch Element



0402 (Molded Plastic DFN Package)

MSWSE-010-15S

Rev. V2

Features

- Small Size (40 x 24 mils)
- Broadband Performance up to 3 GHz
- Supports up to 10 W Power
- Low Insertion Loss, 0.15 dB
- Cost effective choice for switch applications
- RoHS* Compliant

Applications

• ISM

Description

The MSWSE-010-15S is a PIN diode switch element designed for medium incident power applications, up to 10 W CW. It has low insertion loss and medium isolation below 3 GHz.

Electrical Specifications: T_A = +25°C

Parameter	Test Conditions	Min.	Тур.	Max.	Units
Breakdown Voltage	I _R = 10 μA	200	—	—	V
Forward Voltage	I _F = 50 mA	_	870	950	mV
Junction Capacitance	V _R = -50 V, 1 MHz	—	0.13	—	pF
Total Capacitance	V _R = -50 V, 1 MHz	_	0.17	0.22	pF
Series Resistance	I _F = 30 mA, 500 MHz I _F = 100 mA, 500 MHz		0.8 0.6	1.0 0.8	Ω
Lifetime	l _F = 10 mA, l _R = 6 mA , 50%	—	650	900	ns
I-Region	I-Layer	—	10	_	mm
Insertion Loss	I _F = 50 mA, 1 GHz I _F = 50 mA, 2 GHz	_	0.05 0.10	 0.25	dB
Input Return Loss	I _F = 50 mA, 1 GHz I _F = 50 mA, 2 GHz	25 —	30 25	_	dB
Isolation	V _R = 50 V, 1 GHz V _R = 50 V, 2 GHz	15 —	20 15		dB

* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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Absolute Maximum Ratings^{1,2}

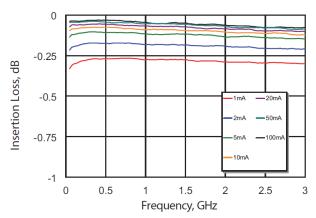
Parameter	Absolute Maximum		
Breakdown Voltage	200 V		
Forward Current	200 mA		
Thermal Resistance	35 W CW		
Junction Temperature	+175°C		
Storage Temperature	-55°C to +150°C		
Solder Temperature	+260°C per JEDEC STD-J-20C		

1. Exceeding any one or combination of these limits may cause permanent damage to this device.

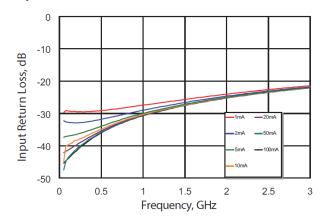
2. MACOM does not recommend sustained operation near these survivability limits.

Typical RF Performance Curves @ +25°C

Insertion Loss

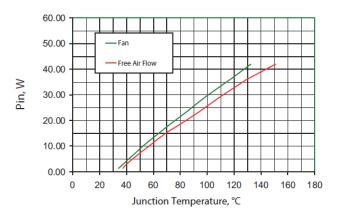


Input Return Loss

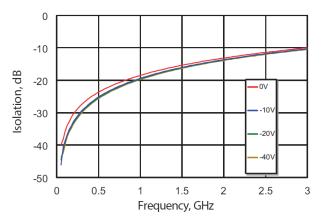


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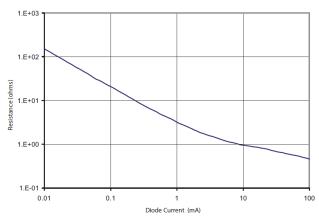
Junction Temperature vs. Input Power Mounted on Heatsink $T_A = 25^{\circ}C$, 1.3 GHz



Isolation







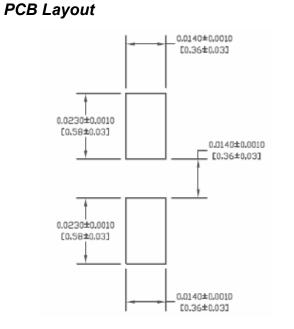
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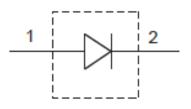


MSWSE-010-15S

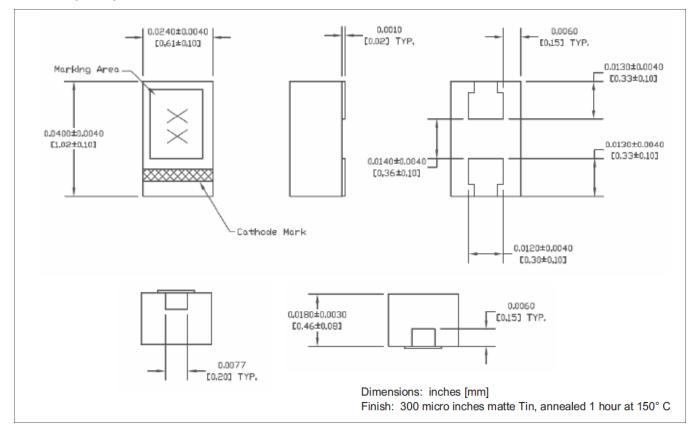
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Schematic



Outline (0402)



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